

**REMARKS**

At the outset, the Examiner is thanked for the thorough review and consideration of the pending application. The Office Action dated June 26, 2008 has been received and its contents carefully reviewed.

Claims 9, 10 and 13 have been amended. Claims 12, 15 and 16 have been deleted. Claims 1-8 and 17-21 have been withdrawn from consideration as the result of the earlier restriction requirement. No new matter has been added. Claims 9-11, 13 and 14 remain pending in this application. Applicant respectfully requests favorable reconsideration in view of the remarks presented herein below.

Claims 9-16 are rejected under 35 U.S.C. §103(a) as being unpatentable over U.S. Patent No. 6,252,247 to Sakata et al. ("Sakata") in view of U.S. Patent No. 6,219,125 to Ishikura et al. ("Ishikura"). Applicant respectfully traverses the rejections as being based upon references that neither teach nor suggest the combination of features recited by independent claim 9, as amended, and hence dependent claims 10, 11, 13 and 14.

With respect to independent claim 9, as amended, Applicant respectfully submits that either Sakata or Ishikura fails to teach or suggest the claimed combination including at least features of "forming an island-shaped metal layer by etching the second copper compound layer and the second copper layer on the ohmic contact layer, wherein the island-shaped metal layer is disposed over the gate line; forming a passivation layer on the island-shaped metal layer, the passivation layer having a second contact hole exposing the island-shaped metal layer; the pixel electrode connected to the island-shaped metal layer through the second contact hole," as recited

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Response to Office Action dated June 26, 2008

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by independent claim 9. Accordingly, claim 9 and its dependent claims 10, 11, 13 and 14 are allowable over the cited references.

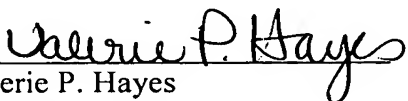
Applicant believes the foregoing amendments place the application in condition for allowance and early, favorable action is respectfully solicited.

If for any reason the Examiner finds the application other than in condition for allowance, the Examiner is requested to call the undersigned attorney at (202) 496-7500 to discuss the steps necessary for placing the application in condition for allowance. All correspondence should continue to be sent to the below-listed address.

If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. § 1.136, and any additional fees required under 37 C.F.R. § 1.136 for any necessary extension of time, or any other fees required to complete the filing of this response, may be charged to Deposit Account No. 50-0911. Please credit any overpayment to deposit Account No. 50-0911.

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Respectfully submitted,

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